

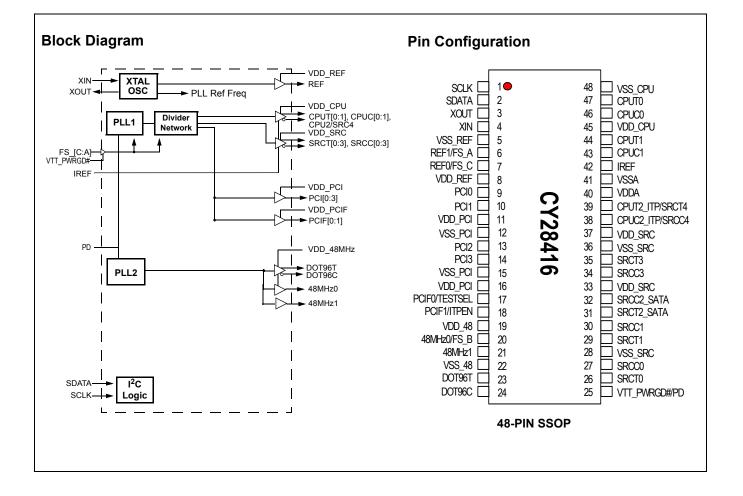
# Next Generation FTG for Intel® Architecture

# Features

- Supports Intel Pentium<sup>®</sup>4-Type CPUs
- Selectable CPU Frequencies
- Two Differential CPU Clock Pairs
- Four 100-MHz Differential SRC Clock Pairs
- One CPU/SRC Selectable Differential Clock Pair
- One 96-MHz Differential Dot Clock Support
- Two 48-MHz Clocks
- Four 33-MHz PCI Clocks

- Two 33-MHz PCI Free Running Clocks
- Low Voltage Frequency Select Input
- I<sup>2</sup>C Support Byte/Word/Block Read/Write Capabilities
- Ideal Lexmark Spread Spectrum Profile for Maximum EMI Reduction
- 3.3V Power Supply
- 48-pin SSOP Package

CPU	SRC	PCI	DOT	USB	REF
x2 / x3	x4 / x5	x 6	x 1	x 2	x 2





# **Pin Definition**

23,24       DOT96T, DOT96C       O, DIF       Differential 96-MHz clock output         6       FS_A/REF1       I/O, SE       3.3V tolerant input for CPU frequency/REF clock Refer to DC Electrical Specifications table for VII_FS and VIh_FS specification         20       FS_B/48 MHz0       I/O, SE       3.3V tolerant input for CPU frequency/REF clock Refer to DC Electrical Specifications table for VII_FS and VIh_FS specification         7       FS_C/REF0       I/O, SE       3.3V tolerant input for CPU frequency/REF clock Refer to DC Electrical Specifications table for VII_FS and VIh_FS specification         42       IREF       I       A precision resistor is attached to this pin, which is connected to the intern current reference.         18       ITP_EN/PCIF1       I/O, SE       33-MHz clock output.         21       48 MHz1       O, SE       33-MHz clock output.         21       48 MHz1       O, SE       34-MHz clock output.         21       SCLK       I       SMBus compatible SDATA.         1       SCLK       I       SMBus compatible SDATA.         2       SDATA       I/O       SMBus compatible SDATA.         31,32       SRCT2_SATA, SRCC2_SATA       O, DIF       Differential Serial reference clock.         19       VDD_48       PWR       3.3V power supply for outputs         45       VDD_CPU	Pin No.	Name	Туре	Description	
CPUC2_ITP/SRCC4         ITP_EN = 0 @VTT_PVRGD# assertion PIN 39,38 = SRCT4,SRCC4           23.24         DOT96T,DOT96C         0, DIF         Differential 96-MHz clock output           6         FS_AREF1         I/0,SE         3.3 V tolerant input for CPU frequency/REF clock           7         FS_EN48 MHz0         I/0,SE         3.3 V tolerant input for CPU frequency/REF clock           7         FS_C/REF0         I/0,SE         3.3 V tolerant input for CPU frequency/REF clock           7         FS_C/REF0         I/0,SE         3.3 V tolerant input for CPU frequency/REF clock           7         FS_C/REF0         I/0,SE         Bable SRC4 or CPU2_ITP/PCIF clock.           82         IREF         I         A precision resistor is attached to this pin, which is connected to the intern current reference.           18         ITP_ENPTCIF1         I/0,SE         Enable SRC4 or CPU2_ITP/PCIF clock.           9,10,13,14         PCI         O,SE         33-MHz clock output.           2         SDATA         I/0         SEMsus compatible SCLOCK.           2,27,29,0,SRC7[0:3]         O,DIF         Differential Serial reference clock.           3,35         SRC72_SATA         I/0         SE           19         VDD_48         PWR         3.3V power supply for outputs           3,37         <	47,46,44,43	CPUT/C[0:1]	O, DIF	Differential CPU clock output.	
6         FS_A/REF1         I/O, SE         3.3V tolerant input for CPU frequency/REF clock Refer to DC Electrical Specifications table for VII_FS and VIh_FS specification (PS_BI48 MHz0)           20         FS_B/48 MHz0         I/O, SE         3.3V tolerant input for CPU frequency/REF clock Refer to DC Electrical Specifications table for VII_FS and VIh_FS specification (PS_C/REF0)           7         FS_C/REF0         I/O, SE         3.3V tolerant input for CPU frequency/REF clock Refer to DC Electrical Specifications table for VII_FS and VIh_FS specification (Current reference.           18         ITP_EN/PCIF1         I/O, SE         Enable SRC4 or CPU2_ITP/PCIF clock. (sampled on the VTT_PVRGD# assertion). 0 = SRC4, 1 = CPU2_ITP (Sigmapped on the VTT_PVRGD# assertion). 0 = SRC4, 1 = CPU2_ITP (Sigmapped on the VTT_PVRGD# assertion). 0 = SRC4, 1 = CPU2_ITP (Sigmapped on the VTT_PVRGD# assertion). 0 = SRC4, 1 = CPU2_ITP (Sigmapped on the VTT_PVRGD# assertion). 0 = SRC4, 1 = CPU2_ITP (Sigmapped on the VTT_PVRGD# assertion). 0 = SRC4, 1 = CPU2_ITP (Sigmapped on the VTT_PVRGD# assertion). 0 = SRC4, 1 = CPU2_ITP (Sigmapped on the VTT_PVRGD# assertion). 0 = SRC4, 1 = CPU2_ITP (Sigmapped on the VTT_PVRGD# assertion). 0 = SRC4, 1 = CPU2_ITP (Sigmapped context of the second (active HIGH)	39,38		O, DIF		
-         Refer to DC Electrical Specifications table for VIL_FS and VIh_FS specification           20         FS_B/48 MHz0         I/O, SE         3.3 V tolerant input for CPU frequency/48 MHz clock           7         FS_C/REF0         I/O, SE         3.3 V tolerant input for CPU frequency/18E F clock           7         FS_C/REF0         I/O, SE         3.3 V tolerant input for CPU frequency/18E F clock           42         IREF         I         A precision resistor is attached to this pin, which is connected to the intern current reference.           18         ITP_EN/PCIF1         I/O, SE         33-MHz clock output           21         48 MHz1         O, SE         33-MHz clock output           21         48 MHz1         O, SE         48-MHz clock output           21         48 MHz1         O, SE         48-MHz clock output           22         SDATA         I/O         SMBus compatible SCLOCK.           2         SDATA         I/O         SMBus compatible SDATA.           26.27, 29.30, 34, 55         SRCT/2_SATA         O, DIF         Differential Serial reference clock.           17         TEST_SEL/PCIF0         I/O, SE, LVTTL input for selecting Hi-Z or Normal operation/33 MHz Clock PD           18         VDD_48         PWR         3.3V power supply for outputs           19 </td <td>23,24</td> <td>DOT96T, DOT96C</td> <td>O, DIF</td> <td>Differential 96-MHz clock output</td>	23,24	DOT96T, DOT96C	O, DIF	Differential 96-MHz clock output	
Perform         Refer to DC Electrical Specifications table for VIL_FS and VIh_FS specifications           7         FS_C/REF0         I/O, SE         3.3V tolerant input for CPU frequency/REF clock           42         IREF         I         A precision resistor is attached to this pin, which is connected to the interm current reference.           18         ITP_EN/PCIF1         I/O, SE         53-MHz clock output.           9,10,13,14         PCI         O, SE         33-MHz clock output.           21         48 MHz1         O, SE         33-MHz clock output.           21         48 MHz1         O, SE         33-MHz clock output.           22         SDATA         I/O         SMBus compatible SCLOCK.           2         SDATA         I/O         SMBus compatible SDATA.           31,32         SRCT2_SATA,         I/O         SMBus compatible Sclock. Recommended output for SATA           17         TEST_SEL/PCIF0         I/O, SE,         LVTTL input for selecting HI-Z or Normal operation/33 MHz Clock           19         VDD_48         PWR         3.3V power supply for outputs           11.16         VDD_PCI         PWR         3.3V power supply for outputs           33,37         VDD_SRC         PWR         3.3V power supply for outputs           33,37         VDD_REF<	6	FS_A/REF1	I/O, SE	E 3.3V tolerant input for CPU frequency/REF clock Refer to DC Electrical Specifications table for Vil_FS and Vih_FS specification	
2       IREF       I       Refer to DC Electrical Specifications table for VIL_FS and VIh_FS specifications table foremain operation for outputs for outputs for VID_FS and VIh_FS spe	20	FS_B/48 MHz0	I/O, SE	<b>3.3V tolerant input for CPU frequency/48 MHz clock</b> Refer to DC Electrical Specifications table for Vil_FS and Vih_FS specifications.	
Lurrent reference.           18         ITP_EN/PCIF1         I/O, SE         Enable SRC4 or CPU2_ITP/PCIF clock. (sampled on the VTT_PWRGD# assertion). 0 = SRC4, 1 = CPU2_ITP           9,10,13,14         PCI         O, SE         33-MHz clock output.           21         48 MHz1         O, SE         48-MHz clock output. (Uses same control SMBus register as 48 MHz0 to cole enable/disable.)           1         SCLK         I         SMBus compatible SCLOCK.           2         SDATA         I/O         SMBus compatible SDATA.           26,27,29,30, 34,35         SRCT2_SATA, SRCC2_SATA         O, DIF         Differential Serial reference clock.           17         TEST_SEL/PCIF0         I/O, SE, PD         Differential Serial reference clock. Recommended output for SATA           19         VDD_48         PWR         3.3V power supply for outputs           11, 16         VDD_PCI         PWR         3.3V power supply for outputs           33, 37         VDD_SRC         PWR         3.3V power supply for outputs           48         VSS_CPU         GND         Ground for outputs           12         VSS_48         GND         Ground for outputs           24         VSS_CPU         GND         Ground for outputs           13,37         VDD_SRC         PWR         3.	7	FS_C/REF0	I/O, SE	<b>3.3V tolerant input for CPU frequency/REF clock</b> Refer to DC Electrical Specifications table for Vil_FS and Vih_FS specifications.	
Image: Second	42	IREF	I	A precision resistor is attached to this pin, which is connected to the internal current reference.	
21       48 MHz1       O, SE <b>48-MHz clock output</b> (Uses same control SMBus register as 48 MHz0 to conenable/disable.)         1       SCLK       I       SMBus compatible SCLOCK.         2       SDATA       I/O       SMBus compatible SDATA.         26,27,29,30, 34,35       SRCT/C[0:3]       O, DIF       Differential Serial reference clock.         31,32       SRCT2_SATA, SRCC2_SATA       O, DIF       Differential Serial reference clock. Recommended output for SATA         17       TEST_SEL/PCIF0       I/O, SE, PD       LVTTL input for selecting HI-Z or Normal operation/33 MHz Clock 0 = Normal operation, 1 = HI-Z when VTT_PWRGD# is sampled         19       VDD_48       PWR       3.3V power supply for outputs         45       VDD_CPU       PWR       3.3V power supply for outputs         11, 16       VDD_PCI       PWR       3.3V power supply for outputs         33, 37       VDD_SRC       PWR       3.3V power supply for outputs         40       VDDA       PVRR       3.3V power supply for outputs         12, 15       VSS_PCI       GND       Ground for outputs         5       VSS_SRC       GND       Ground for outputs         28,36       VSS_SRC       GND       Ground for outputs         28,36       VSS_SRC       GND       Gro	18	ITP_EN/PCIF1	I/O, SE		
Indextenable/disable.)1SCLKISMBus compatible SCLOCK.2SDATAI/OSMBus compatible SDATA.26,27,29,30, 34,35SRCT/C[0:3]O, DIFDifferential Serial reference clock.31,32SRCT2_SATA, SRCC2_SATAO, DIFDifferential Serial reference clock. Recommended output for SATA17TEST_SEL/PCIF0I/O, SE, PDLVTTL input for selecting Hi-Z or Normal operation/33 MHz Clock 0 = Normal operation, 1 = HI-Z when VTT_PWRGD# is sampled19VDD_48PWR3.3V power supply for outputs45VDD_CPUPWR3.3V power supply for outputs11, 16VDD_REFPWR3.3V power supply for outputs33, 37VDD_SRCPWR3.3V power supply for outputs40VDDAPWR3.3V power supply for outputs48VSS_CPUGNDGround for outputs5VSS_REFGNDGround for outputs5VSS_REFGNDGround for outputs41VSSAGNDGround for outputs28,36VSS_SRCGNDGround for PLL25VTT_PWRGD#/PDI, PD3.3V LVTTL Input. This pin is a level-sensitive strobe used to latch the FS FS B, FS C/TEST SEL, and PCI/O/TP_EN Inputs. After asserting vTT_PWRGD#/PD4XINI14.318-MHz Crystal Input	9,10,13,14	PCI	O, SE	33-MHz clock output.	
2       SDATA       I/O       SMBus compatible SDATA.         26,27,29,30, 34,35       SRCT/C[0:3]       O, DIF       Differential Serial reference clock.         31,32       SRCT2_SATA, SRCC2_SATA       O, DIF       Differential Serial reference clock. Recommended output for SATA         17       TEST_SEL/PCIF0       I/O, SE, PD       LVTTL input for selecting HI-Z or Normal operation/33 MHz Clock 0 = Normal operation, 1 = HI-Z when VTT_PWRGD# is sampled         19       VDD_48       PWR       3.3V power supply for outputs         45       VDD_CPU       PWR       3.3V power supply for outputs         11, 16       VDD_PCI       PWR       3.3V power supply for outputs         33, 37       VDD_SRC       PWR       3.3V power supply for outputs         40       VDA       PWR       3.3V power supply for outputs         12       VSS_48       GND       Ground for outputs         48       VSS_CPU       GND       Ground for outputs         12, 15       VSS_REF       GND       Ground for outputs         28,36       VSS_SRC       GND       Ground for outputs         28,36       VSS_SRC       GND       Ground for outputs         29       VSS_AB       GND       Ground for outputs         20       VSS_SRC<	21	48 MHz1	O, SE	<b>48-MHz clock output</b> . (Uses same control SMBus register as 48 MHz0 to control enable/disable.)	
26.27,29,30, 34,35       SRCT/C[0:3]       O, DIF       Differential Serial reference clock.         31,32       SRCT2_SATA, SRCC2_SATA       O, DIF       Differential Serial reference clock. Recommended output for SATA SRCC2_SATA         17       TEST_SEL/PCIF0       I/O, SE, PD       LVTTL input for selecting HI-Z or Normal operation/33 MHz Clock 0 = Normal operation, 1 = HI-Z when VTT_PWRGD# is sampled         19       VDD_48       PWR       3.3V power supply for outputs         45       VDD_CPU       PWR       3.3V power supply for outputs         11, 16       VDD_REF       PWR       3.3V power supply for outputs         33, 37       VDD_SRC       PWR       3.3V power supply for outputs         40       VDDA       PWR       3.3V power supply for outputs         12       VSS_48       GND       Ground for outputs         48       VSS_CPU       GND       Ground for outputs         12, 15       VSS_REF       GND       Ground for outputs         28, 36       VSS_SRC       GND       Ground for outputs         21       VSSA       GND       Ground for Outputs         22       VSS_REF       GND       Ground for outputs         5       VSS_REF       GND       Ground for outputs         2	1	SCLK	I	SMBus compatible SCLOCK.	
34,35       34,35       0, DIF       Differential Serial reference clock. Recommended output for SATA         31,32       SRCT2_SATA       0, DIF       Differential Serial reference clock. Recommended output for SATA         17       TEST_SEL/PCIF0       I/O, SE, PD       LVTTL input for selecting HI-Z or Normal operation/33 MHz Clock         19       VDD_48       PWR       3.3V power supply for outputs         45       VDD_CPU       PWR       3.3V power supply for outputs         11, 16       VDD_PCI       PWR       3.3V power supply for outputs         8       VDD_REF       PWR       3.3V power supply for outputs         33, 37       VDD_SRC       PWR       3.3V power supply for outputs         40       VDDA       PWR       3.3V power supply for outputs         48       VSS_CPU       GND       Ground for outputs         12, 15       VSS_REF       GND       Ground for outputs         5       VSS_REF       GND       Ground for outputs         41       VSSA       GND       Ground for outputs         25       VTT_PWRGD#/PD       I, PD       3.3V LVTTL Input. This pin is a level-sensitive strobe used to latch the FS FS_B, FS_C/TEST_SEL, and PCIF0/ITP_EN Inputs. After asserting vTT_PWRGD#/(active LOW), this pin becomes a realtime input for asserti power-down (active HIGH)     <	2	SDATA	I/O	SMBus compatible SDATA.	
SRCC2_SATA17TEST_SEL/PCIF0I/O, SE, PDLVTTL input for selecting HI-Z or Normal operation/33 MHz Clock 0 = Normal operation, 1 = HI-Z when VTT_PWRGD# is sampled19VDD_48PWR3.3V power supply for outputs45VDD_CPUPWR3.3V power supply for outputs11, 16VDD_PCIPWR3.3V power supply for outputs8VDD_REFPWR3.3V power supply for outputs33, 37VDD_SRCPWR3.3V power supply for outputs40VDDAPWR3.3V power supply for outputs22VSS_48GNDGround for outputs48VSS_CPUGNDGround for outputs5VSS_REFGNDGround for outputs28, 36VSS_SRCGNDGround for outputs41VSSAGNDGround for outputs25VTT_PWRGD#/PDI, PDS3V LVTTL Input. This pin is a level-sensitive strobe used to latch the FS FS_B, FS_C/TEST_SEL, and PCIF0/ITP_EN Inputs. After asserting VTT_PWRGD# (active LOW), this pin becomes a realtime input for asserti power-down (active HIGH)4XINI14.318-MHz Crystal Input		SRCT/C[0:3]	O, DIF	Differential Serial reference clock.	
PD0 = Normal operation, 1 = HI-Z when VTT_PWRGD# is sampled19VDD_48PWR3.3V power supply for outputs45VDD_CPUPWR3.3V power supply for outputs11, 16VDD_PCIPWR3.3V power supply for outputs8VDD_REFPWR3.3V power supply for outputs33, 37VDD_SRCPWR3.3V power supply for outputs40VDDAPWR3.3V power supply for PLL22VSS_48GNDGround for outputs48VSS_CPUGNDGround for outputs5VSS_REFGNDGround for outputs5VSS_REFGNDGround for outputs41VSSAGNDGround for outputs25VTT_PWRGD#/PDI, PD <b>3.3V LVTTL Input</b> . This pin is a level-sensitive strobe used to latch the FS FS_B, FS_C/TEST_SEL, and PCIF0/ITP_EN Inputs. After asserting VTT_PWRGD#/ACtive LOW), this pin becomes a realtime input for asserting power-down (active HIGH)4XINI14.318-MHz Crystal Input	31,32		O, DIF	Differential Serial reference clock. Recommended output for SATA	
45       VDD_CPU       PWR       3.3V power supply for outputs         11, 16       VDD_PCI       PWR       3.3V power supply for outputs         8       VDD_REF       PWR       3.3V power supply for outputs         33, 37       VDD_SRC       PWR       3.3V power supply for outputs         40       VDDA       PWR       3.3V power supply for outputs         40       VDA       PWR       3.3V power supply for outputs         22       VSS_48       GND       Ground for outputs         48       VSS_CPU       GND       Ground for outputs         12, 15       VSS_PCI       GND       Ground for outputs         5       VSS_REF       GND       Ground for outputs         28, 36       VSS_SRC       GND       Ground for outputs         41       VSSA       GND       Ground for PLL         25       VTT_PWRGD#/PD       I, PD       3.3V LVTTL Input. This pin is a level-sensitive strobe used to latch the FS FS_B, FS_C/TEST_SEL, and PCIF0/ITP_EN Inputs. After asserting VTT_PWRGD# (active LOW), this pin becomes a realtime input for asserting vert-down (active HIGH)         4       XIN       I       14.318-MHz Crystal Input	17	TEST_SEL/PCIF0		LVTTL input for selecting HI-Z or Normal operation/33 MHz Clock 0 = Normal operation, 1 = HI-Z when VTT_PWRGD# is sampled	
11, 16       VDD_PCI       PWR       3.3V power supply for outputs         8       VDD_REF       PWR       3.3V power supply for outputs         33, 37       VDD_SRC       PWR       3.3V power supply for outputs         40       VDDA       PWR       3.3V power supply for PLL         22       VSS_48       GND       Ground for outputs         48       VSS_CPU       GND       Ground for outputs         12, 15       VSS_REF       GND       Ground for outputs         5       VSS_REF       GND       Ground for outputs         28, 36       VSS_SRC       GND       Ground for Outputs         41       VSSA       GND       Ground for PLL         25       VTT_PWRGD#/PD       I, PD       3.3V LVTTL Input. This pin is a level-sensitive strobe used to latch the FS FS_B, FS_C/TEST_SEL, and PCIF0/ITP_EN Inputs. After asserting VTT_PWRGD# (active LOW), this pin becomes a realtime input for asserting vTT_PWRGD# (active LOW), this pin becomes a realtime input for asserting vTT_PWRGD# (active HIGH)         4       XIN       I       14.318-MHz Crystal Input	19	VDD_48	PWR	3.3V power supply for outputs	
8       VDD_REF       PWR       3.3V power supply for outputs         33, 37       VDD_SRC       PWR       3.3V power supply for outputs         40       VDDA       PWR       3.3V power supply for PLL         22       VSS_48       GND       Ground for outputs         48       VSS_CPU       GND       Ground for outputs         12, 15       VSS_PCI       GND       Ground for outputs         5       VSS_REF       GND       Ground for outputs         28, 36       VSS_SRC       GND       Ground for PLL         25       VTT_PWRGD#/PD       I, PD <b>3.3V LVTTL Input</b> . This pin is a level-sensitive strobe used to latch the FS         FS_B, FS_C/TEST_SEL, and PCIF0/ITP_EN Inputs. After asserting       VTT_PWRGD# (active LOW), this pin becomes a realtime input for asserti power-down (active HIGH)         4       XIN       I       14.318-MHz Crystal Input	45	VDD_CPU	PWR	3.3V power supply for outputs	
33, 37       VDD_SRC       PWR       3.3V power supply for outputs         40       VDDA       PWR       3.3V power supply for PLL         22       VSS_48       GND       Ground for outputs         48       VSS_CPU       GND       Ground for outputs         12, 15       VSS_PCI       GND       Ground for outputs         5       VSS_REF       GND       Ground for outputs         28, 36       VSS_SRC       GND       Ground for outputs         41       VSSA       GND       Ground for PLL         25       VTT_PWRGD#/PD       I, PD <b>3.3V LVTTL Input</b> . This pin is a level-sensitive strobe used to latch the FS FS_B, FS_C/TEST_SEL, and PCIF0/ITP_EN Inputs. After asserting VTT_PWRGD# (active LOW), this pin becomes a realtime input for asserti power-down (active HIGH)         4       XIN       I       14.318-MHz Crystal Input	11, 16	VDD_PCI	PWR	3.3V power supply for outputs	
40       VDDA       PWR       3.3V power supply for PLL         22       VSS_48       GND       Ground for outputs         48       VSS_CPU       GND       Ground for outputs         12, 15       VSS_PCI       GND       Ground for outputs         5       VSS_REF       GND       Ground for outputs         28, 36       VSS_SRC       GND       Ground for outputs         41       VSSA       GND       Ground for PLL         25       VTT_PWRGD#/PD       I, PD       3.3V LVTTL Input. This pin is a level-sensitive strobe used to latch the FS FS_B, FS_C/TEST_SEL, and PCIF0/ITP_EN Inputs. After asserting VTT_PWRGD# (active LOW), this pin becomes a realtime input for asserting power-down (active HIGH)         4       XIN       I       14.318-MHz Crystal Input	8	VDD_REF	PWR	3.3V power supply for outputs	
22       VSS_48       GND       Ground for outputs         48       VSS_CPU       GND       Ground for outputs         12, 15       VSS_PCI       GND       Ground for outputs         5       VSS_REF       GND       Ground for outputs         28, 36       VSS_SRC       GND       Ground for outputs         41       VSSA       GND       Ground for PLL         25       VTT_PWRGD#/PD       I, PD <b>3.3V LVTTL Input</b> . This pin is a level-sensitive strobe used to latch the FS FS_B, FS_C/TEST_SEL, and PCIF0/ITP_EN Inputs. After asserting VTT_PWRGD# (active LOW), this pin becomes a realtime input for asserting over-down (active HIGH)         4       XIN       I       14.318-MHz Crystal Input	33, 37	VDD_SRC	PWR	3.3V power supply for outputs	
48       VSS_CPU       GND       Ground for outputs         12, 15       VSS_PCI       GND       Ground for outputs         5       VSS_REF       GND       Ground for outputs         28, 36       VSS_SRC       GND       Ground for outputs         41       VSSA       GND       Ground for PLL         25       VTT_PWRGD#/PD       I, PD       3.3V LVTTL Input. This pin is a level-sensitive strobe used to latch the FS FS_B, FS_C/TEST_SEL, and PCIF0/ITP_EN Inputs. After asserting VTT_PWRGD# (active LOW), this pin becomes a realtime input for asserting power-down (active HIGH)         4       XIN       I       14.318-MHz Crystal Input	40	VDDA	PWR	3.3V power supply for PLL	
12, 15       VSS_PCI       GND       Ground for outputs         5       VSS_REF       GND       Ground for outputs         28, 36       VSS_SRC       GND       Ground for outputs         41       VSSA       GND       Ground for PLL         25       VTT_PWRGD#/PD       I, PD       3.3V LVTTL Input. This pin is a level-sensitive strobe used to latch the FS FS_B, FS_C/TEST_SEL, and PCIF0/ITP_EN Inputs. After asserting VTT_PWRGD# (active LOW), this pin becomes a realtime input for asserting power-down (active HIGH)         4       XIN       I       14.318-MHz Crystal Input	22	VSS_48	GND	Ground for outputs	
5       VSS_REF       GND       Ground for outputs         28, 36       VSS_SRC       GND       Ground for outputs         41       VSSA       GND       Ground for PLL         25       VTT_PWRGD#/PD       I, PD       3.3V LVTTL Input. This pin is a level-sensitive strobe used to latch the FS FS_B, FS_C/TEST_SEL, and PCIF0/ITP_EN Inputs. After asserting VTT_PWRGD# (active LOW), this pin becomes a realtime input for asserting power-down (active HIGH)         4       XIN       I       14.318-MHz Crystal Input	48	VSS_CPU	GND	Ground for outputs	
28, 36       VSS_SRC       GND       Ground for outputs         41       VSSA       GND       Ground for PLL         25       VTT_PWRGD#/PD       I, PD <b>3.3V LVTTL Input</b> . This pin is a level-sensitive strobe used to latch the FS FS_B, FS_C/TEST_SEL, and PCIF0/ITP_EN Inputs. After asserting VTT_PWRGD# (active LOW), this pin becomes a realtime input for asserting power-down (active HIGH)         4       XIN       I       14.318-MHz Crystal Input	12, 15	VSS_PCI	GND	Ground for outputs	
41       VSSA       GND       Ground for PLL         25       VTT_PWRGD#/PD       I, PD <b>3.3V LVTTL Input</b> . This pin is a level-sensitive strobe used to latch the FS FS_B, FS_C/TEST_SEL, and PCIF0/ITP_EN Inputs. After asserting VTT_PWRGD# (active LOW), this pin becomes a realtime input for asserting power-down (active HIGH)         4       XIN       I       14.318-MHz Crystal Input	5	VSS_REF	GND	Ground for outputs	
25       VTT_PWRGD#/PD       I, PD <b>3.3V LVTTL Input</b> . This pin is a level-sensitive strobe used to latch the FS FS_B, FS_C/TEST_SEL, and PCIF0/ITP_EN Inputs. After asserting VTT_PWRGD# (active LOW), this pin becomes a realtime input for asserting power-down (active HIGH)         4       XIN       I       14.318-MHz Crystal Input	28, 36	VSS_SRC	GND	Ground for outputs	
FS_B, FS_C/TEST_SEL, and PCIF0/ITP_EN Inputs. After asserting VTT_PWRGD# (active LOW), this pin becomes a realtime input for asserting power-down (active HIGH)         4       XIN       I       14.318-MHz Crystal Input	41	VSSA	GND	Ground for PLL	
	25	VTT_PWRGD#/PD	I, PD	VTT_PWRGD# (active LOW), this pin becomes a realtime input for asserting	
3 XOUT O 14.318-MHz Crystal Output	4	XIN	I	14.318-MHz Crystal Input	
	3	XOUT	0	14.318-MHz Crystal Output	



# Frequency Select Pins (FS\_A, FS\_B, and FS\_C)

Host clock frequency selection is achieved by applying the appropriate logic levels to FS\_A, FS\_B, FS\_C inputs prior to VTT\_PWRGD# assertion (as seen by the clock synthesizer). Upon VTT\_PWRGD# being sampled LOW by the clock chip (indicating processor VTT voltage is stable), the clock chip samples the FS\_A, FS\_B, and FS\_C input values. For all logic levels of FS\_A, FS\_B, and FS\_C VTT\_PWRGD# employs a one-shot functionality in that once a valid LOW on VTT\_PWRGD# has been sampled, all further VTT\_PWRGD#, FS\_A, FS\_B, and FS\_C transitions will be ignored, except in test mode.

# Serial Data Interface

To enhance the flexibility and function of the clock synthesizer, a two-signal serial interface is provided. Through the Serial Data Interface, various device functions, such as individual clock output buffers, can be individually enabled or disabled. The registers associated with the Serial Data Interface initial-

Table 1. Frequency Select Table (FS\_A FS\_B)

izes to their default setting upon power-up, and therefore use of this interface is optional. Clock device register changes are normally made upon system initialization, if any are required. The interface cannot be used during system operation for power management functions.

# **Data Protocol**

The clock driver serial protocol accepts byte write, byte read, block write, and block read operations from the controller. For block write/read operation, the bytes must be accessed in sequential order from lowest to highest byte (most significant bit first) with the ability to stop after any complete byte has been transferred. For byte write and byte read operations, the system controller can access individually indexed bytes. The offset of the indexed byte is encoded in the command code, as described in *Table 2*.

The block write and block read protocol is outlined in *Table 3* while *Table 4* outlines the corresponding byte write and byte read protocol. The slave receiver address is 11010010 (D2h).

FS_C	FS_B	FS_A	CPU	SRC	PCIF/PCI	REF0	DOT96	USB
1	0	1	100 MHz	100 MHz	33 MHz	14.318 MHz	96 MHz	48 MHz
0	0	1	133 MHz	100 MHz	33 MHz	14.318 MHz	96 MHz	48 MHz
0	1	1	166 MHz	100 MHz	33 MHz	14.318 MHz	96 MHz	48 MHz
0	1	0	200 MHz	100 MHz	33 MHz	14.318 MHz	96 MHz	48 MHz
0	0	0	266 MHz	100 MHz	33 MHz	14.318 MHz	96 MHz	48 MHz
1	0	0	333 MHz	100 MHz	33 MHz	14.318 MHz	96 MHz	48 MHz
1	1	0	400 MHz	100 MHz	33 MHz	14.318 MHz	96 MHz	48 MHz
1	1	1	Reserved	100 MHz	33 MHz	14.318 MHz	96 MHz	48 MHz

 Table 2. Command Code Definition

	Bit	Description
	7	0 = Block read or block write operation, 1 = Byte read or byte write operation
Ī	(6:0)	Byte offset for byte read or byte write operation. For block read or block write operations, these bits should be '0000000'

#### Table 3. Block Read and Block Write Protocol

	Block Write Protocol		Block Read Protocol
Bit	Description	Bit	Description
1	Start	1	Start
8:2	Slave address – 7 bits	8:2	Slave address – 7 bits
9	Write	9	Write
10	Acknowledge from slave	10	Acknowledge from slave
18:11	Command Code – 8 Bits	18:11	Command Code – 8 Bits
19	Acknowledge from slave	19	Acknowledge from slave
27:20	Byte Count – 8 bits (Skip this step if I <sup>2</sup> C_EN bit set)	20	Repeat start
28	Acknowledge from slave	27:21	Slave address – 7 bits
36:29	Data byte 1 – 8 bits	28	Read = 1
37	Acknowledge from slave	29	Acknowledge from slave
45:38	Data byte 2 – 8 bits	37:30	Byte Count from slave – 8 bits
46	Acknowledge from slave	38	Acknowledge



### Table 3. Block Read and Block Write Protocol (continued)

	Block Write Protocol	Block Read Protocol		
Bit	Description	Bit	Description	
	Data Byte /Slave Acknowledges	46:39	Data byte 1 from slave – 8 bits	
	Data Byte N –8 bits	47	Acknowledge	
	Acknowledge from slave	55:48	Data byte 2 from slave – 8 bits	
	Stop	56	Acknowledge	
			Data bytes from slave / Acknowledge	
			Data Byte N from slave – 8 bits	
			NOT Acknowledge	
			Stop	

# Table 4. Byte Read and Byte Write protocol

	Byte Write Protocol		Byte Read Protocol
Bit	Description	Bit	Description
1	Start	1	Start
8:2	Slave address – 7 bits	8:2	Slave address – 7 bits
9	Write	9	Write
10	Acknowledge from slave	10	Acknowledge from slave
18:11	Command Code – 8 bits	18:11	Command Code – 8 bits
19	Acknowledge from slave	19	Acknowledge from slave
27:20	Data byte – 8 bits	20	Repeated start
28	Acknowledge from slave	27:21	Slave address – 7 bits
29	Stop	28	Read
		29	Acknowledge from slave
		37:30	Data from slave – 8 bits
		38	NOT Acknowledge
		39	Stop

# **Control Registers**

## Byte 0:Control Register 0

Bit	@Pup	Name	Description
7	1	CPUT2_ITP/SRCT4 CPUC2_ITP/SRCC4	CPU[T/C]2_ITP/SRC[T/C]4 Output Enable 0 = Disable (Hi-Z), 1 = Enable
6	1	RESERVED	RESERVED, Set = 1
5	1	RESERVED	RESERVED, Set = 1
4	1	SRC[T/C]3	SRC[T/C]3 Output Enable 0 = Disable (Hi-Z), 1 = Enable
3	1	SRC[T/C]2_SATA	SRC[T/C]2_SATA Output Enable 0 = Disable (Hi-Z), 1 = Enable
2	1	SRC[T/C]1	SRC[T/C]1 Output Enable 0 = Disable (Hi-Z), 1 = Enable
1	1	SRC[T/C]0	SRC[T/C]0 Output Enable 0 = Disable (Hi-Z), 1 = Enable
0	1	RESERVED	RESERVED, Set = 1



Byte 1: Control Register 1

Bit	@Pup	Name	Description
7	1	RESERVED	RESERVED, Set = 1
6	1	DOT_96T/C	DOT_96 MHz Output Enable 0 = Disable (Hi-Z), 1 = Enabled
5	1	48 MHz0, 48 MHz1	48 MHz Output Enable 0 = Disabled, 1 = Enabled
4	1	REF0	REF Output Enable 0 = Disabled, 1 = Enabled
3	1	REF1	REF Output Enable 0 = Disabled, 1 = Enabled
2	1	CPU[T/C]1	CPU[T/C]1 Output Enable 0 = Disable (Hi-Z), 1 = Enabled
1	1	CPU[T/C]0	CPU[T/C]0 Output Enable 0 = Disable (Hi-Z), 1 = Enabled
0	0	CPUT/C SRCT/C PCIF PCI	Spread Spectrum Enable 0 = Spread off, 1 = Spread on

# Byte 2: Control Register 2

Bit	@Pup	Name	Description
7	1	PCI3	PCl3 Output Enable 0 = Disabled, 1 = Enabled
6	1	PCI2	PCl2 Output Enable 0 = Disabled, 1 = Enabled
5	1	RESERVED	RESERVED, Set = 1
4	1	RESERVED	RESERVED, Set = 1
3	1	PCI1	PCI1 Output Enable 0 = Disabled, 1 = Enabled
2	1	PCI0	PCI0 Output Enable 0 = Disabled, 1 = Enabled
1	1	PCIF1	PCIF2 Output Enable 0 = Disabled, 1 = Enabled
0	1	PCIF0	PCIF1 Output Enable 0 = Disabled, 1 = Enabled

# Byte 3: Control Register 3

Bit	@Pup	Name	Description
7	0	SRC[T/C]4	Allow control of SRC[T/C]4 with assertion of SW PCI_STP# 0 = Free running, 1 = Stopped with PCI_STP#
6	0	RESERVED	RESERVED, Set = 0
5	0	RESERVED	RESERVED, Set = 0
4	0	SRC[T/C]3	Allow control of SRC[T/C]3 with assertion of SW PCI_STP# 0 = Free running, 1 = Stopped with PCI_STP#
3	0	SRC2_SATA	Allow control of SRC2_SATA with assertion of SW PCI_STP# 0 = Free running, 1 = Stopped with PCI_STP#
2	0	SRC[T/C]1	Allow control of SRC[T/C]1 with assertion of SW PCI_STP# 0 = Free running, 1 = Stopped with PCI_STP#
1	0	SRC[T/C]0	Allow control of SRC[T/C]1 with assertion of SW PCI_STP# 0 = Free running, 1 = Stopped with PCI_STP#
0	0	RESERVED	RESERVED, Set = 0



# Byte 4: Control Register 4

Bit	@Pup	Name	Description
7	0	RESERVED	RESERVED, Set = 0
6	0	DOT96[T/C]	DOT_PWRDWN Drive Mode 0 = Driven in PWRDWN, 1 = Tri-state
5	0	PCIF1	Allow control of PCIF2 with assertion of SW PCI_STP# 0 = Free running, 1 = Stopped with PCI_STP#
4	0	PCIF0	Allow control of PCIF1 with assertion of SW PCI_STP# 0 = Free running, 1 = Stopped with PCI_STP#
3	0	RESERVED	RESERVED, Set = 0
2	1	RESERVED	RESERVED, Set = 1
1	1	RESERVED	RESERVED, Set = 1
0	1	RESERVED	RESERVED, Set = 1

### Byte 5: Control Register 5

Bit	@Pup	Name	Description			
7	0	SRC[T/C][4:0]	SRC[T/C] Stop Drive Mode 0 = Driven when SW PCI_STP# asserted,1 = Tri-state when SW PCI_STP# asserted			
6	0	RESERVED	RESERVED, Set = 0			
5	0	RESERVED	RESERVED, Set = 0			
4	0	RESERVED	RESERVED, Set = 0			
3	0	SRC[T/C][4:0]	SRC[T/C] PWRDWN Drive Mode 0 = Driven when PD asserted,1 = Tri-state when PD asserted			
2	0	CPU[T/C]2_ITP	CPU[T/C]2_ITP PWRDWN Drive Mode 0 = Driven when PD asserted,1 = Tri-state when PD asserted			
1	0	CPU[T/C]1	CPU[T/C]1 PWRDWN Drive Mode 0 = Driven when PD asserted,1 = Tri-state when PD asserted			
0	0	CPU[T/C]0	CPU[T/C]0 PWRDWN Drive Mode 0 = Driven when PD asserted,1 = Tri-state when PD asserted			

# Byte 6: Control Register 6

Bit	@Pup	Name	Description
7	0	RESERVED	RESERVED, Set = 0
6	0		Test Clock Mode Entry Control 0 = Normal operation, 1 = Hi-Z mode
5	1	REF1	REF1 Output Drive Strength 0 = Low, 1 = High
4	1	REF0	REF0 Output Drive Strength 0 = Low, 1 = High
3	1	PCIF, SRC, PCI	SW PCI_STP# Function 0=SW PCI_STP assert, 1= SW PCI_STP deassert When this bit is set to 0, all STOPPABLE PCI, PCIF, and SRC outputs will be stopped in a synchronous manner with no short pulses. When this bit is set to 1, all STOPPED PCI, PCIF, and SRC outputs will resume in a synchronous manner with no short pulses.
2	Externally selected		FS_C. Reflects the value of the FS_C pin sampled on power-up 0 = FS_C was low during VTT_PWRGD# assertion
1	Externally selected		FS_B. Reflects the value of the FS_B pin sampled on power-up 0 = FS_B was low during VTT_PWRGD# assertion
0	Externally selected		FS_A. Reflects the value of the FS_A pin sampled on power-up 0 = FS_A was low during VTT_PWRGD# assertion



#### Byte 7: Vendor ID

Bit	@Pup	Name	Description
7	0	Revision Code Bit 3	Revision Code Bit 3
6	0	Revision Code Bit 2	Revision Code Bit 2
5	0	Revision Code Bit 1	Revision Code Bit 1
4	1	Revision Code Bit 0	Revision Code Bit 0
3	1	Vendor ID Bit 3	Vendor ID Bit 3
2	0	Vendor ID Bit 2	Vendor ID Bit 2
1	0	Vendor ID Bit 1	Vendor ID Bit 1
0	0	Vendor ID Bit 0	Vendor ID Bit 0

#### Table 5. Crystal Recommendations

Frequency (Fund)	Cut	Loading	Load Cap	Drive (max.)	Shunt Cap (max.)	Motional (max.)	Tolerance (max.)	Stability (max.)	Aging (max.)
14.31818 MHz	AT	Parallel	20 pF	0.1mW	5 pF	0.016 pF	50 ppm	50 ppm	5 ppm

### **Crystal Recommendations**

The CY28416 requires a **Parallel Resonance Crystal**. Substituting a series resonance crystal will cause the CY28416 to operate at the wrong frequency and violate the ppm specification. For most applications there is a 300-ppm frequency shift between series and parallel crystals due to incorrect loading.

### **Crystal Loading**

Crystal loading plays a critical role in achieving low ppm performance. To realize low ppm performance, the total capacitance the crystal will see must be considered to calculate the appropriate capacitive loading (CL).

*Figure 1* shows a typical crystal configuration using the two trim capacitors. An important clarification for the following discussion is that the trim capacitors are in series with the crystal, not parallel. It's a common misconception that load capacitors are in parallel with the crystal and should be approximately equal to the load capacitance of the crystal. This is **not true.** 

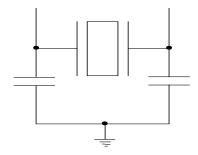
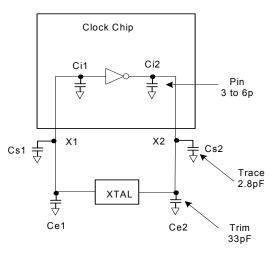


Figure 1. Crystal Capacitive Clarification

### **Calculating Load Capacitors**

In addition to the standard external trim capacitors, trace capacitance and pin capacitance must also be considered to correctly calculate crystal loading. As mentioned previously, the capacitance on each side of the crystal is in series with the crystal. This means the total capacitance on each side of the crystal load capacitance (CL). While the capacitance on each side of the crystal is in series with the crystal, trim capacitors (Ce1,Ce2) should be calculated to provide equal capacitive loading on both sides.



#### Figure 2. Crystal Loading Example

As mentioned previously, the capacitance on each side of the crystal is in series with the crystal. This mean the total capacitance on each side of the crystal must be 2 times the specified load capacitance(CL). While the capacitance on each side of the crystal is in series with the crystal, trim capacitors(Ce1,Ce2) should be calculated to provide equal capacitance loading on both sides.



CY28416

Use the following formulas to calculate the trim capacitor values for Ce1 and Ce2.

#### Load Capacitance (each side)

Ce = 2 \* CL - (Cs + Ci)

#### Total Capacitance (as seen by the crystal)

$$CLe = \frac{1}{\left(\frac{1}{Ce1 + Cs1 + Ci1} + \frac{1}{Ce2 + Cs2 + Ci2}\right)}$$

CL	Crystal load capacitance
CLe using standard value trim capa	Actual loading seen by crystal acitors
Ce	External trim capacitors
Cs	Stray capacitance (terraced)
Ci (lead frame, bond wires etc.)	Internal capacitance

#### PD (Power-down) Clarification

The VTT\_PWRGD# /PD pin is a dual function pin. During initial power-up, the pin functions as VTT\_PWRGD#. Once VTT\_PWRGD# has been sampled low by the clock chip, the pin assumes PD functionality. The PD pin is an asynchronous active high input used to shut off all clocks cleanly prior to shutting off power to the device. This signal needs to be synchronized internal to the device prior to powering down the clock synthesizer. PD is also an asynchronous input for powering up the system. When PD is asserted high, all clocks need to be driven to a low value and held prior to turning off the VCOs and the crystal oscillator.

#### PD (Power-down)—Assertion

When PD is sampled high by two consecutive rising edges of CPUC, all single-ended outputs must be held low on their next high to low transition and differential clocks must held high or tri-stated (depending on the state of the control register drive mode bit) on the next diff clock# high to low transition. When the SMBus PD drive mode bit corresponding to the differential (CPU, SRC, and DOT) clock output of interest is programmed to '0', the clock output must be held with "Diff clock" pin driven high at 2 x Iref, and "Diff clock#" tristate. If the control register PD drive mode bit corresponding to the output of interest is programmed to "1", then both the "Diff clock" and the "Diff clock#" are tri-state. Note the example in Figure 3 shows CPUT = 133 MHz and PD drive mode = '1' for all differential outputs. This diagram and description is applicable to valid CPU frequencies 100, 133, 166, 200, 266, 333, and 400 MHz. In the event that PD mode is desired as the initial power-on state, PD must be asserted high in less than 10 µs after asserting VTT PWRGD#.

#### **PD Deassertion**

The power-up latency needs to be less than 1.8 ms. This is the time from the deassertion of the PD pin or the ramping of the power supply until the time that stable clocks are output from the clock chip. All differential outputs stopped in a tristate condition resulting from power down must be driven high in less than 300  $\mu$ s of PD deassertion to a voltage greater than 200 mV. After the clock chip's internal PLL is powered up and locked, all outputs are to be enabled within a few clock cycles of each other. *Figure 4* is an example showing the relationship of clocks coming up. Unfortunately, we can not show all possible combinations, designers need to insure that from the first active clock output to the last takes no more than two full PCI clock cycles.

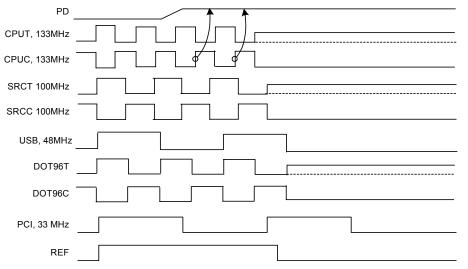
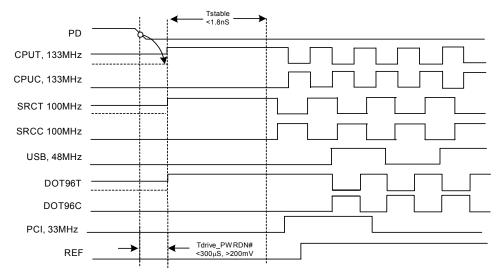
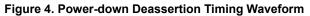
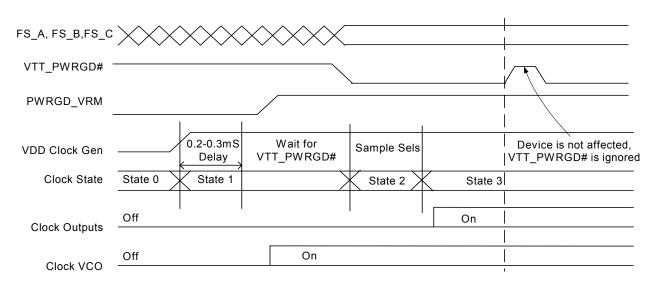


Figure 3. Power-down Assertion Timing Waveform

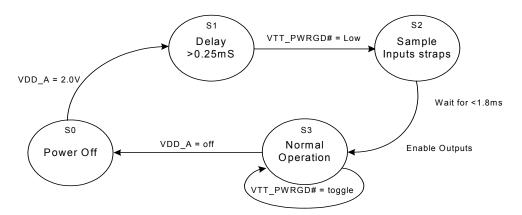


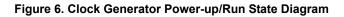














# **Absolute Maximum Conditions**

Parameter	Description	Condition	Min.	Max.	Unit
V <sub>DD</sub>	Core Supply Voltage		-0.5	4.6	V
V <sub>DD_A</sub>	Analog Supply Voltage		-0.5	4.6	V
V <sub>IN</sub>	Input Voltage	Relative to V <sub>SS</sub>	-0.5	V <sub>DD</sub> + 0.5	VDC
T <sub>S</sub>	Temperature, Storage	Non-functional	-65	150	°C
T <sub>A</sub>	Temperature, Operating Ambient	Functional	0	70	°C
TJ	Temperature, Junction	Functional	-	150	°C
Ø <sub>JC</sub>	Dissipation, Junction to Case	Mil-Spec 883E Method 1012.1	-	15	°C/W
Ø <sub>JA</sub>	Dissipation, Junction to Ambient	JEDEC (JESD 51)	-	45	°C/W
ESD <sub>HBM</sub>	ESD Protection (Human Body Model)	MIL-STD-883, Method 3015	2000	-	V
UL-94	Flammability Rating	At 1/8 in.		V-0	
MSL	Moisture Sensitivity Level			1	

Multiple Supplies: The Voltage on any input or I/O pin cannot exceed the power pin during power-up. Power supply sequencing is NOT required.

# **DC Electrical Specifications**

Parameter	Description	Condition	Min.	Max.	Unit
VDD_A VDD_REF, VDD_PCI, VDD_3V66, VDD_48, VDD_CPU	3.3V Operating Voltage	3.3 ± 5%	3.135	3.465	V
V <sub>ILI2C</sub>	Input Low Voltage	SDATA, SCLK	-	1.0	V
V <sub>IHI2C</sub>	Input High Voltage	SDATA, SCLK	2.2	-	V
V <sub>IL_FS</sub>	FS_[A:C] Input Low Voltage		0.7	V <sub>DD</sub> + 0.5	V
V <sub>IH_FS</sub>	FS_[A:C] Input High Voltage		$V_{SS} - 0.3$	0.35	V
V <sub>IL</sub>	Input Low Voltage		$V_{SS} - 0.5$	0.8	V
V <sub>IH</sub>	Input High Voltage		2.0	V <sub>DD</sub> + 0.5	V
IIL	Input Low Leakage Current	Except internal pull-up resistors, 0 < V <sub>IN</sub> < V <sub>DD</sub>	-5		μA
I <sub>IH</sub>	Input High Leakage Current	Except internal pull-down resistors, $0 < V_{IN} < V_{DD}$		5	μA
V <sub>OL</sub>	Output Low Voltage	I <sub>OL</sub> = 1 mA	-	0.4	V
V <sub>OH</sub>	Output High Voltage	I <sub>OH</sub> = -1 mA	2.4	-	V
I <sub>OZ</sub>	High-impedance Output Current		-10	10	μA
C <sub>IN</sub>	Input Pin Capacitance		2	5	pF
C <sub>OUT</sub>	Output Pin Capacitance		3	6	pF
L <sub>IN</sub>	Pin Inductance		_	7	nH
V <sub>XIH</sub>	Xin High Voltage		0.7V <sub>DD</sub>	V <sub>DD</sub>	V
V <sub>XIL</sub>	Xin Low Voltage		0	0.3V <sub>DD</sub>	V
I <sub>DD3.3V</sub>	Dynamic Supply Current	At max load and freq per Table 6 and Figure 7	-	400	mA
I <sub>PD3.3V</sub>	Power-down Supply Current	PD asserted, Outputs driven	-	70	mA
I <sub>PD3.3V</sub>	Power-down Supply Current	PD asserted, Outputs Tri-stated	-	2	mA



# **AC Electrical Specifications**

Parameter	Description	Condition	Min.	Max.	Unit
Crystal				I	
T <sub>DC</sub>	XIN Duty Cycle	The device will operate reliably with input duty cycles up to 30/70 but the REF clock duty cycle will not be within specification	47.5	52.5	%
T <sub>PERIOD</sub>	XIN Period	When XIN is driven from an external clock source	69.841	71.0	ns
T <sub>R</sub> / T <sub>F</sub>	XIN Rise and Fall Times	Measured between $0.3V_{DD}$ and $0.7V_{DD}$	-	10.0	ns
T <sub>CCJ</sub>	XIN Cycle to Cycle Jitter	As an average over 1-µs duration	-	500	ps
L <sub>ACC</sub>	Long-term Accuracy	Over 150 ms	-	300	ppm
CPU at 0.7	V				
T <sub>DC</sub>	CPUT and CPUC Duty Cycle	Measured at crossing point V <sub>OX</sub>	45	55	%
T <sub>PERIOD</sub>	100-MHz CPUT and CPUC Period	Measured at crossing point V <sub>OX</sub>	9.9970	10.003	ns
T <sub>PERIOD</sub>	133-MHz CPUT and CPUC Period	Measured at crossing point V <sub>OX</sub>	7.4978	7.5023	ns
T <sub>PERIOD</sub>	166-MHz CPUT and CPUC Period	Measured at crossing point V <sub>OX</sub>	5.9982	6.0018	ns
T <sub>PERIOD</sub>	200-MHz CPUT and CPUC Period	Measured at crossing point V <sub>OX</sub>	4.9985	5.0015	ns
T <sub>PERIOD</sub>	266-MHz CPUT and CPUC Period	Measured at crossing point V <sub>OX</sub>	3.7489	3.7511	ns
T <sub>PERIOD</sub>	333-MHz CPUT and CPUC Period	Measured at crossing point V <sub>OX</sub>	2.9991	3.0009	ns
T <sub>PERIOD</sub>	400-MHz CPUT and CPUC Period	Measured at crossing point V <sub>OX</sub>	2.4993	2.5008	ns
	100-MHz CPUT and CPUC Period, SSC		9.9970	10.0533	ns
	133-MHz CPUT and CPUC Period, SSC		7.4978	7.5400	ns
	166-MHz CPUT and CPUC Period, SSC		5.9982	6.0320	ns
	200-MHz CPUT and CPUC Period, SSC		4.9985	5.0266	ns
	266-MHz CPUT and CPUC Period, SSC		3.7489	3.7700	ns
	333-MHz CPUT and CPUC Period, SSC		2.9991	3.0160	ns
			2.4993	2.5133	ns
T <sub>SKEW</sub>	Any CPUT/C to CPUT/C Clock Skew, SSC	Measured at crossing point V <sub>OX</sub>	_	100	ps
T <sub>CCJ</sub>	CPUT/C Cycle to Cycle Jitter	Measured at crossing point V <sub>OX</sub>	_	85	ps
T <sub>CCJ</sub>	CPU2/SRC4 Cycle to Cycle Jitter	Measured at crossing point V <sub>OX</sub>	_	125	ps
T <sub>R</sub> / T <sub>F</sub>	CPUT and CPUC Rise and Fall Times	Measured from $V_{OL}$ = 0.175 to $V_{OH}$ = 0.525V	175	700	ps
T <sub>RFM</sub>	Rise/Fall Matching	Determined as a fraction of $2^{*}(T_{R} - T_{F})/(T_{R} + T_{F})$	_	20	%
$\Delta T_R$	Rise Time Variation		_	125	ps
$\Delta T_F$	Fall Time Variation		_	125	ps
V <sub>HIGH</sub>	Voltage High	Math averages <i>Figure</i> 7	660	850	mv
V <sub>LOW</sub>	Voltage Low	Math averages <i>Figure</i> 7	-150	_	mv
V <sub>OX</sub>	Crossing Point Voltage at 0.7V Swing		250	550	mv
V <sub>OVS</sub>	Maximum Overshoot Voltage		_	V <sub>HIGH</sub> + 0.3	V
V <sub>UDS</sub>	Minimum Undershoot Voltage		-0.3	_	V
V <sub>RB</sub>	Ring Back Voltage	See Figure 7. Measure SE	_	0.2	V
SRC	<del>_</del>			I	
T <sub>DC</sub>	SRCT and SRCC Duty Cycle	Measured at crossing point V <sub>OX</sub>	45	55	%
T <sub>PERIOD</sub>	100-MHz SRCT and SRCC Period	Measured at crossing point V <sub>OX</sub>	9.9970	10.003	ns
T <sub>PERIODSS</sub>	100-MHz SRCT and SRCC Period, SSC	Measured at crossing point V <sub>OX</sub>	9.9970	10.0533	ns
T <sub>SKEW</sub>	Any SRCT/C to SRCT/C Clock Skew	Measured at crossing point V <sub>OX</sub>	_	100	ps
T <sub>CCJ</sub>	SRCT/C Cycle to Cycle Jitter	Measured at crossing point V <sub>OX</sub>	_	125	ps



# AC Electrical Specifications (continued)

Parameter	Description	Condition	Min.	Max.	Unit
L <sub>ACC</sub>	SRCT/C Long Term Accuracy	Measured at crossing point V <sub>OX</sub>	_	300	ppm
T <sub>R</sub> / T <sub>F</sub>	SRCT and SRCC Rise and Fall Times	Measured from $V_{OL}$ = 0.175 to $V_{OH}$ = 0.525V	175	700	ps
T <sub>RFM</sub>	Rise/Fall Matching	Determined as a fraction of $2^{(T_R - T_F)/(T_R + T_F)}$	-	20	%
$\Delta T_R$	Rise Time Variation		_	125	ps
$\Delta T_F$	Fall Time Variation		_	125	ps
V <sub>HIGH</sub>	Voltage High	Math averages Figure 7	660	850	mv
V <sub>LOW</sub>	Voltage Low	Math averages Figure 7	-150	_	mv
V <sub>OX</sub>	Crossing Point Voltage at 0.7V Swing		250	550	mV
V <sub>OVS</sub>	Maximum Overshoot Voltage		-	V <sub>HIGH</sub> + 0.3	V
V <sub>UDS</sub>	Minimum Undershoot Voltage		-0.3	-	V
V <sub>RB</sub>	Ring Back Voltage	See Figure 7. Measure SE	-	0.2	V
PCI/PCIF					
T <sub>DC</sub>	PCI Duty Cycle	Measurement at 1.5V	45	55	%
T <sub>PERIOD</sub>	Spread Disabled PCIF/PCI Period	Measurement at 1.5V	29.9910	30.0090	ns
T <sub>PERIOD</sub>	Spread Enabled PCIF/PCI Period	Measurement at 1.5V	29.9910	30.1598	ns
T <sub>HIGH</sub>	PCIF and PCI high time	Measurement at 2.4V	12.0	-	ns
T <sub>LOW</sub>	PCIF and PCI low time	Measurement at 0.4V	12.0	-	ns
T <sub>R</sub> / T <sub>F</sub>	PCIF and PCI rise and fall times	Measured between 0.4V and 2.4V	0.5	2.0	ns
T <sub>SKEW</sub>	Any PCI clock to Any PCI clock Skew	Measurement at 1.5V	-	500	ps
T <sub>CCJ</sub>	PCIF and PCI Cycle to Cycle Jitter	Measurement at 1.5V	-	250	ps
DOT					
T <sub>DC</sub>	DOT96T and DOT96C Duty Cycle	Measured at crossing point $V_{OX}$	45	55	%
T <sub>PERIOD</sub>	DOT96T and DOT96C Period	Measured at crossing point $V_{OX}$	10.4135	10.4198	ns
Т <sub>ССЈ</sub>	DOT96T/C Cycle to Cycle Jitter	Measured at crossing point $V_{OX}$	-	250	ps
L <sub>ACC</sub>	DOT96T/C Long Term Accuracy	Measured at crossing point $V_{OX}$	1	300	ppm
T <sub>R</sub> / T <sub>F</sub>	DOT96T and DOT96C Rise and Fall Times	Measured from V <sub>OL</sub> = 0.175 to V <sub>OH</sub> = 0.525V	175	700	ps
T <sub>RFM</sub>	Rise/Fall Matching	Determined as a fraction of $2^{(T_R - T_F)/(T_R + T_F)}$	-	20	%
$\Delta T_R$	Rise Time Variation		-	125	ps
$\Delta T_F$	Fall Time Variation		-	125	ps
V <sub>HIGH</sub>	Voltage High	Math averages Figure 7	660	850	mv
V <sub>LOW</sub>	Voltage Low	Math averages Figure 7	-150	-	mv
V <sub>OX</sub>	Crossing Point Voltage at 0.7V Swing		250	550	mV
V <sub>OVS</sub>	Maximum Overshoot Voltage		-	V <sub>HIGH</sub> + 0.3	V
V <sub>UDS</sub>	Minimum Undershoot Voltage		-0.3	-	V
V <sub>RB</sub>	Ring Back Voltage	See Figure 7. Measure SE	-	0.2	V
USB					
T <sub>DC</sub>	Duty Cycle	Measurement at 1.5V	45	55	%
T <sub>PERIOD</sub>	Period	Measurement at 1.5V	20.8271	20.8396	ns
T <sub>HIGH</sub>	USB high time	Measurement at 2.4V	8.094	10.036	ns
T <sub>LOW</sub>	USB low time	Measurement at 0.4V	7.694	9.836	ns
T <sub>R</sub> / T <sub>F</sub>	Rise and Fall Times	Measured between 0.4V and 2.4V	1.0	2.0	ns
T <sub>CCJ</sub>	Cycle to Cycle Jitter	Measurement at 1.5V	-	350	ps



# AC Electrical Specifications (continued)

Parameter	Description	Condition	Min.	Max.	Unit
REF					
T <sub>DC</sub>	REF Duty Cycle	Measurement at 1.5V	45	55	%
T <sub>PERIOD</sub>	REF Period	Measurement at 1.5V	69.8203	69.8622	ns
T <sub>R</sub> / T <sub>F</sub>	REF Rise and Fall Times	Measured between 0.4V and 2.4V	0.5	2.0	V/ns
T <sub>CCJ</sub>	REF Cycle to Cycle Jitter	Measurement at 1.5V	-	1000	ps
ENABLE/D	ISABLE and SETUP				
T <sub>STABLE</sub>	Clock Stabilization from Power-up		-	1.8	ms
T <sub>SS</sub>	Stopclock Set-up Time		10.0	-	ns
T <sub>SH</sub>	Stopclock Hold Time		0	_	ns

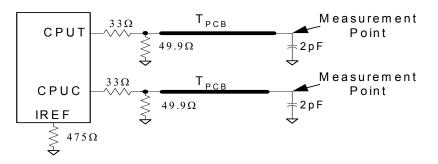
#### Table 6. Maximum Lumped Capacitive Output Loads

Clock	Max Load	Unit
PCI Clocks	30	pF
48M Clock	20	pF
REF Clock	30	pF

### **Test and Measurement Set-up**

### For Differential CPU and SRC Output Signals

The following diagram shows lumped test load configurations for the differential Host Clock Outputs.



### Figure 7. 0.7V Load Configuration

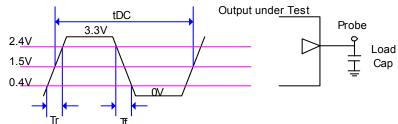


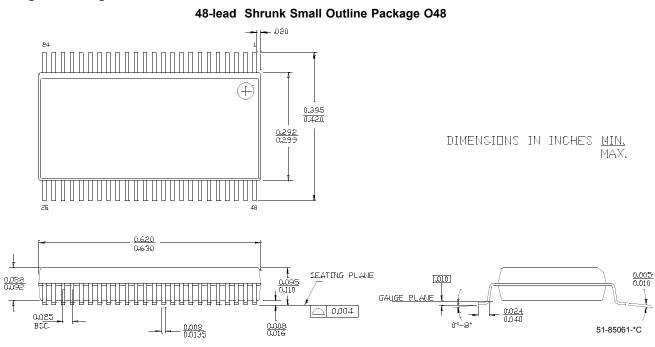
Figure 8. Lumped Load For Single-ended Output Signals (for AC Parameters Measurement)

# **Ordering Information**

Part Number	Package Type	Product Flow
Lead-free		
CY28416OXC	48-pin SSOP	Commercial, 0° to 70°C
CY28416OXCT	48-pin SSOP—Tape and Reel	Commercial, 0° to 70°C



## **Package Drawings and Dimensions**



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# Document History Page

Document Title: CY28416 Next Generation FTG for Intel® Architecture Document #: 38-07657 Rev. *A				
REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change
**	224420	See ECN	RGL/TUJ	New Data Sheet
*A	318277	See ECN	RGL	Changed VTTPWRGD and PCIF0 pins from PU to PD